

NGW50T65H3DFP

650 V, 50 A high speed trench field-stop IGBT with full rated silicon diode

Rev. 1 — 28 June 2024

Product data sheet

1. General description

The NGW50T65H3DFP is a robust Insulated-Gate Bipolar Transistor (IGBT) featuring third-generation technology. It combines carrier stored trench-gate and field-stop (FS) structures. The NGW50T65H3DFP is rated to 175 °C with optimized IGBT turn-off losses. This hard-switching 650 V, 50 A IGBT is optimized for high-voltage, high-frequency industrial power inverter applications.

2. Features and benefits

- Collector current (I_C) rated at 50 A
- Low conduction and switching losses
- Stable and tight parameters for easy parellel operation
- Maximum junction temperature of 175 °C
- · Fully rated as a soft fast reverse recovery diode
- · RoHS compliant, lead-free plating

3. Applications

- Power inverters
 - · Uninterruptible Power Supply (UPS) inverter
 - Photovoltaic (PV) strings
 - EV charging
- Induction heating
- Welding

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CE}	collector-emitter voltage	T _j = 25 °C	-	650	V
Tj	operating junction temperature		-40	+175	°C



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	mb	
2	С	collector		C
3	Е	emitter		
mb	С	mounting base; connected to collector		G E aaa-036518

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
NGW50T65H3DFP	TO-247-3L	Plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3-lead TO-247-3L	SOT429-2			

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
IGBT					
V_{CE}	collector-emitter voltage	T _j = 25 °C	-	650	V
I _C	collector current	$T_{case} = 25 ^{\circ}C$ [1]	-	80	Α
		$T_{case} = 100 ^{\circ}C$ [2]	-	54	Α
I _{Cpuls}	peak pulse collector current [3]		-	200	А
V_{GS}	gate-source voltage		-20	+20	V
P _{tot}	total power dissipation	T _{case} = 25 °C	-	340	W
		T _{case} = 100 °C	-	170	W
Tj	operating junction temperature		-40	+175	°C
T _{stg}	storage temperature		-55	+150	°C
T _{solder}	soldering temperature		-	260	°C
М	mounting torque, M3 screw		-	0.5	Nm
Diode					
I _F	diode forward current	$T_{case} = 25 ^{\circ}C$ [1]	-	80	Α
		$T_{case} = 100 ^{\circ}C$ [1]	-	68	Α
I _{Fpuls}	peak pulse diode current [3]	T _{case} = 25 °C		200	Α

Value limited by bondwire and $T_{j(\text{max})}$.

 t_p limited by $T_{j(max)}$ t_p limited by $T_{j(max)}$.

8. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
· ·ui(j-c)	thermal resistance from	IGBT	-	0.37	0.44	K/W
	junction to case	diode	-	0.52	0.64	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	-	40	K/W

9. Characteristics

Table 6. Characteristics

All values at T_i = 25 °C, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics			1		
V _{(BR)CE}	collector-emitter stop voltage	V _{GE} = 0 V; I _C = 0.2 mA	650	-	-	V
V _{CEsat}	collector-emitter saturation	V _{GE} = 15 V; I _C = 50 A; T _j = 25 °C	-	1.72	2.2	٧
	voltage	V _{GE} = 15 V; I _C = 50 A; T _j = 175 °C	-	2.25	-	V
V _F	diode forward voltage	V _{GE} = 0 V; I _F = 50 A; T _j = 25 °C	-	1.45	2.1	V
		V _{GE} = 0 V; I _F = 50A; T _j = 175 °C	-	1.2	-	V
V _{GE(th)}	gate-emitter threshold voltage	$I_C = 0.5 \text{ mA}; V_{CE} = V_{GE}; T_j = 25 \text{ °C}$	4.3	5	5.7	٧
I _{CES}	zero gate voltage collector	V _{CE} = 650 V; V _{GE} = 0 V; T _j = 25 °C	-	10	- 2.2 - 2.1 - 5.7 - 100 	nA
	current	V _{CE} = 650 V; V _{GE} = 0 V; T _j = 175 °C	-	0.6	-	mA
I _{GES}	gate-emitter leakage current	V _{CE} = 0 V; V _{GE} = 20 V	-	-	100	nA
9 _{fS}	transconductance	V _{CE} = 20 V; I _C = 50 A; T _j = 25 °C	-	28	-	S
r _G	integrated gate resistor		-	1.6	-	Ω
Dynamic	characteristics					
C _{ies}	input capacitance	V _{CE} = 25 V; V _{GE} = 0 V; f = 1 MHz	-	2210	-	pF
C _{oes}	output capacitance		-	180	-	pF
C _{res}	reverse transfer capacitance		-	16.5	-	pF
Q _G	gate charge	V _{CC} = 520 V; V _{GE} = 15 V; I _C = 50 A	-	85	-	nC
L _{sCE}	internal stray inductance	measured 5 mm from case	-	7.9	-	nΗ

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
IGBT sw	vitching characteristics, inductiv	e load					
t _{d(on)}	turn-on delay time	V _{GE} = 15 V to 0 V;	T _j = 25 °C	-	20	-	ns
		$V_{CC} = 400 \text{ V}; I_C = 50 \text{ A};$ $r_{G(on)} = 10 \Omega; r_{G(off)} = 10 \Omega;$	T _j = 175 °C	-	20	-	ns
t _r	increase time	see <u>Fig. 27</u> and <u>Fig. 28</u>	T _j = 25 °C	-	36	-	ns
			T _j = 175 °C	-	36	-	ns
t _{d(off)}	turn-off delay time		T _j = 25 °C	-	98	-	ns
			T _j = 175 °C	-	125	-	ns
t _f	decrease time		T _j = 25 °C	-	32	-	ns
			T _j = 175 °C	-	36	-	ns
E _{on}	turn-on switching loss		T _j = 25 °C	-	1.70	-	mJ
			T _j = 175 °C	-	3.52	-	mJ
E _{off}	turn-off switching loss		T _j = 25 °C	-	0.50	-	mJ
			T _j = 175 °C	-	0.76	-	mJ
E _{ts}	total switching loss		T _j = 25 °C	-	2.20	20 -	mJ
			T _j = 175 °C	-	4.28	-	mJ
Diode sv	witching characteristics, inducti	ve load					
t _{rr}	diode reverse recovery time	V _R = 400 V; I _F = 50 A;	T _j = 25 °C	-	145	-	ns
		$\Delta I_F/\Delta t = 500 \text{ A/}\mu\text{s}$; see Fig. 26	T _j = 175 °C	-	260		ns
Q _{rr}	diode reverse recovery charge		T _j = 25 °C	-	1170	-	nC
			T _j = 175 °C	-	5370	-	nC
I _{rrm}	diode peak reverse recovery		T _j = 25 °C	-	20	-	Α
	current		T _j = 175 °C	-	37	-	Α
E _{rr}	opposite recovery energy		T _j = 25 °C	-	0.12	-	mJ
			T _j = 175 °C	-	0.65	-	mJ
di _{rr} /dt	diode peak rate of decrease of	1	T _j = 25 °C	-	160	-	A/µs
	reverse recovery current		T _i = 175 °C	-	185	-	A/µs

9.1. Output characteristics

Table 7. Waveforms and output characteristics

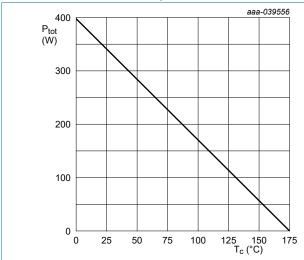


Fig. 1. Power dissipation (P_{tot}) as a function of case temperature

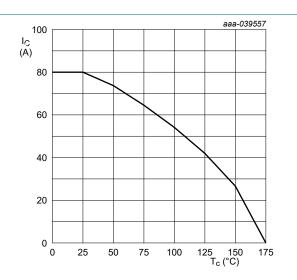
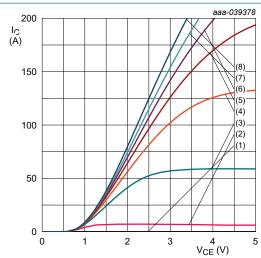


Fig. 2. Collector current (I_C) as a function of case temperature



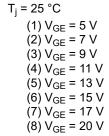
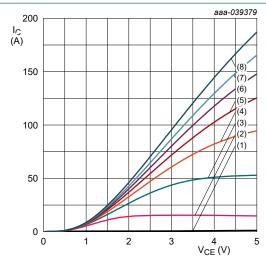


Fig. 3. Collector current as a function of collectoremitter voltage



```
(1) V_{GE} = 5 \text{ V}

(2) V_{GE} = 7 \text{ V}

(3) V_{GE} = 9 \text{ V}

(4) V_{GE} = 11 \text{ V}

(5) V_{GE} = 13 \text{ V}

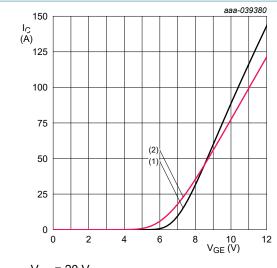
(6) V_{GE} = 15 \text{ V}

(7) V_{GE} = 17 \text{ V}

(8) V_{GE} = 20 \text{ V}
```

T_i = 175 °C

Fig. 4. Collector current as a function of collectoremitter voltage



$$V_{CE} = 20 \text{ V}$$

(1) $T_j = 25 \text{ °C}$
(2) $T_i = 175 \text{ °C}$

Fig. 5. Collector current as a function of gate-emitter voltage; typical values

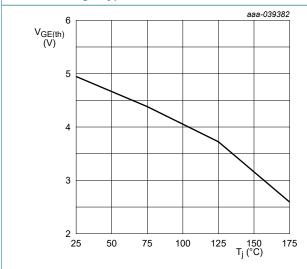


Fig. 7. Gate-emitter threshold voltage as a function of junction temperature

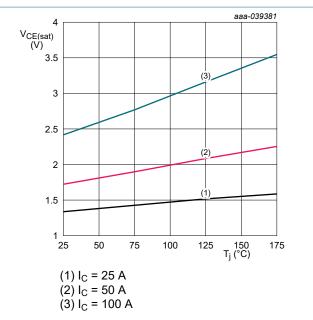
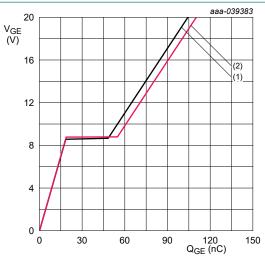
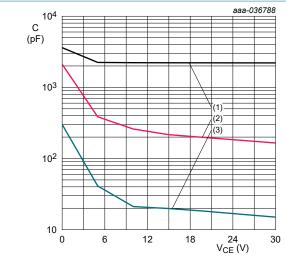


Fig. 6. Collector-emitter saturation voltage as a function of junction temperature; typical values



 $I_C = 50 \text{ A}$ (1) $V_{CE} = 130 \text{ V}$ (2) $V_{CE} = 520 \text{ V}$

Fig. 8. Gate-emitter voltage as a function of gate charge; typical values



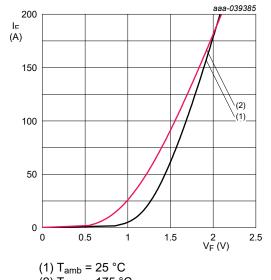
 $V_{GE} = 0 V; f = 1 MHz$

(1) C_{ies}

(2) C_{oes}

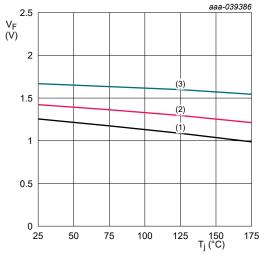
(3) C_{res}

Fig. 9. Typcial capacitance as a function of collectoremitter voltage



(2) $T_{amb} = 175 \, ^{\circ}C$

Fig. 10. Typical diode forward current as a function of forward voltage

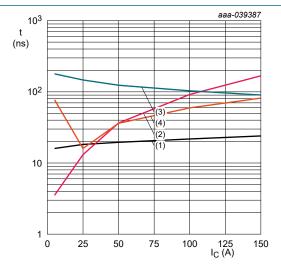


(1) $I_F = 25 A$

(2) $I_F = 50 A$

 $(3) I_F = 100 A$

Fig. 11. Typical diode forward voltage as a function of junction temperature



 V_{GE} = 15 V to 0 V; V_{CC} = 400 V; $r_{G(on)}$ = 10 $\Omega;$ $r_{G(off)}$ = 10 Ω

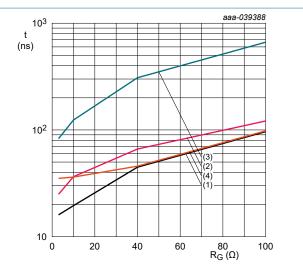
(1) t_{d(on)}

 $(2) t_r$

 $(3) t_{d(off)}$

(4) t_f

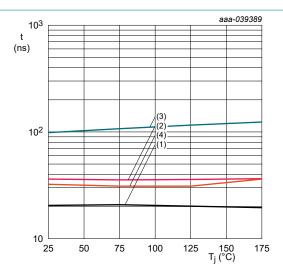
Fig. 12. Typical switching times as a function of collector current



 V_{GE} = 15 V to 0 V; V_{CC} = 400 V; I_{C} = 50 A; T_{j} = 175

- (1) $t_{d(on)}$
- $(2) t_r$
- $(3) t_{d(off)}$
- $(4) t_f$

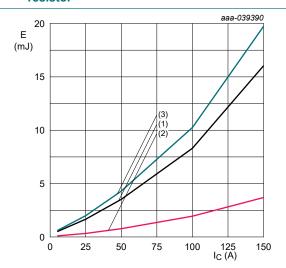
Fig. 13. Typcial switching times as a function of gate resistor



 V_{GE} = 15 V to 0 V; I_{C} = 50 A; V_{CC} = 400 V; $r_{G(on)}$ = 10 Ω; $r_{G(off)} = 10 Ω$

- (1) t_{d(on)}
- $(2) t_r$
- $(3) t_{d(off)}$
- $(4) t_f$

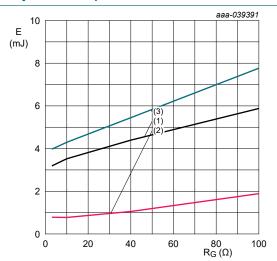
Fig. 14. Typical switching times as a function of junction temperature



 V_{GE} = 15 V to 0 V; V_{CC} = 400 V; $r_{G(on)}$ = 10 $\Omega;$ $r_{G(off)}$ = 10Ω ; T_i = $175 ^{\circ}$ C

- (1) E_{on}
- (2) E_{off}
- (3) E_{ts}

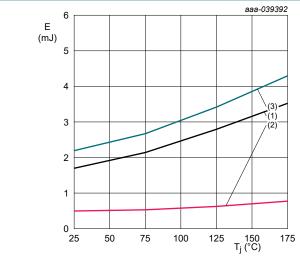
Fig. 15. Typical switching energy losses as a function of Fig. 16. Typical switching energy losses as a function of collector current



 V_{GE} = 15 V to 0 V; V_{CC} = 400 V; I_{C} = 50 A; T_{i} = 175

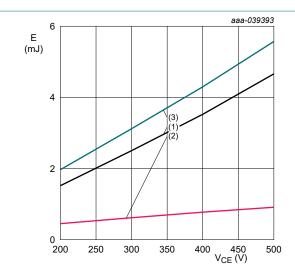
- (1) E_{on}
- (2) E_{off}
- (3) E_{ts}

gate resistance



 V_{GE} = 15 V to 0 V; I_{C} = 50 A; V_{CC} = 400 V; $r_{G(on)}$ = 10 Ω; $r_{G(off)} = 10 Ω$

- (1) E_{on}
- (2) E_{off}
- (3) E_{ts}

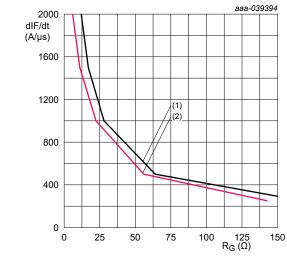


 V_{GE} = 15 V to 0 V; I_{C} = 50 A; $r_{G(on)}$ = 10 $\Omega;$ $r_{G(off)}$ = 10 $\Omega;$ T_{j} = 175 °C

- (1) E_{on}
- (2) E_{off}
- (3) E_{ts}

Fig. 17. Typical switching energy losses as a function of Fig. 18. Typical switching energy losses as a function of junction temperature

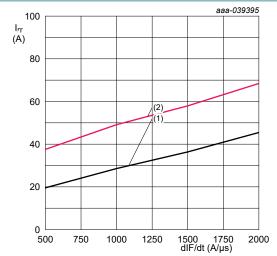
collector-emitter voltage



 $V_R = 400 \text{ V}; I_F = 50 \text{ A}$

- (1) $T_{amb} = 25 \, ^{\circ}C$
- (2) $T_{amb} = 175 \, ^{\circ}C$

Fig. 19. Typical rate of change of forward current as a function of gate resistance



 $V_R = 400 \text{ V}; I_F = 50 \text{ A}$

- (1) $T_{amb} = 25 \, ^{\circ}C$
- (2) $T_{amb} = 175 \, ^{\circ}C$

Fig. 20. Typical reverse recovery current as a function of rate of change of forward current

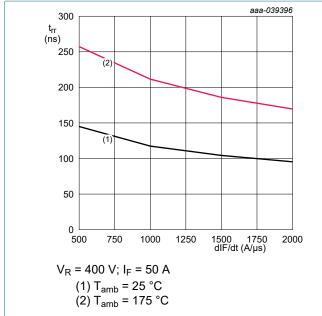


Fig. 21. Typical reverse recovery time as a function of rate of change of forward current

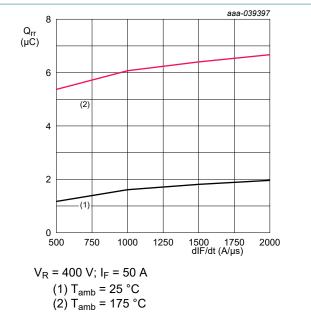
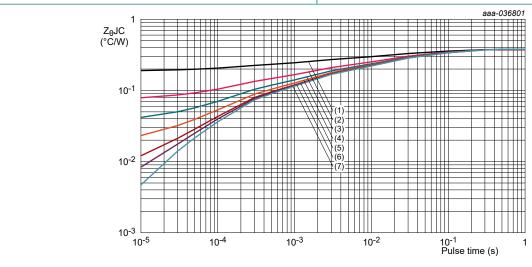
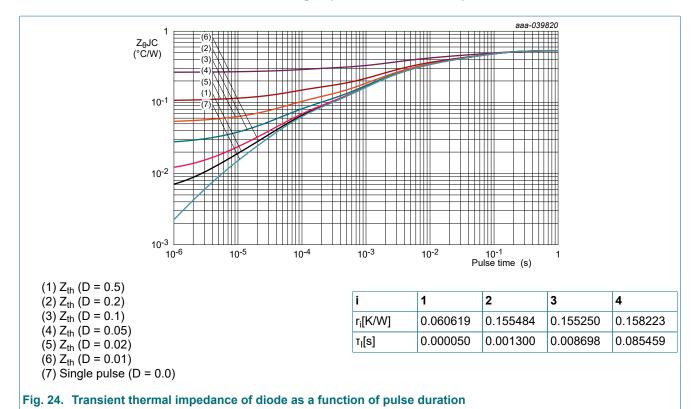


Fig. 22. Typical reverse recovery charge as a function of rate of change of forward current

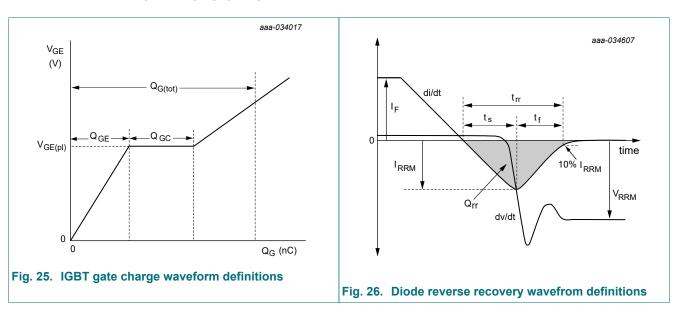


- (1) Z_{th} (D = 0.5) (2) Z_{th} (D = 0.2) (3) Z_{tt} (D = 0.1)
- (3) Z_{th} (D = 0.1) (4) Z_{th} (D = 0.05)
- (5) Z_{th} (D = 0.02)
- (6) Z_{th} (D = 0.01)
- $(0) Z_{th} (D 0.01)$
- (7) Single pulse (D = 0.0)

Fig. 23. Transient thermal impedance of IGBT as a function of pulse duration



9.2. Waveforms



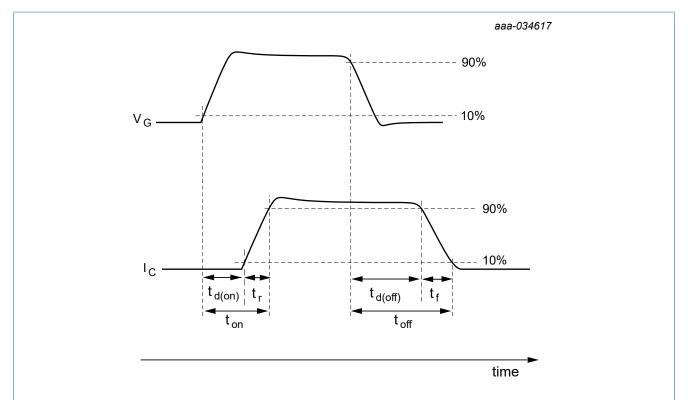
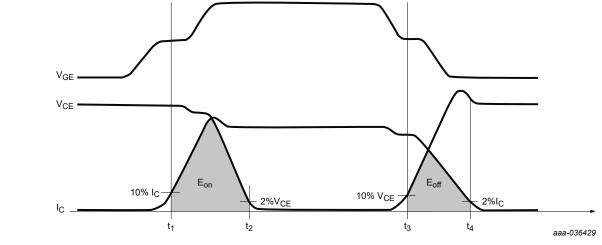


Fig. 27. IGBT switching times definitions



$$E_{\text{on}} = {}^{t_2}_{t_1} V_{\text{CE}} I_C dt$$

$$E_{\text{on}} = {}^{t_2}_{t_1} V_{\text{CE}} I_C dt$$

$$E_{\text{off}} = {}^{t_4}_{t_3} V_{\text{CE}} I_C dt$$

Fig. 28. IGBT switching loss definitions

10. Package outline

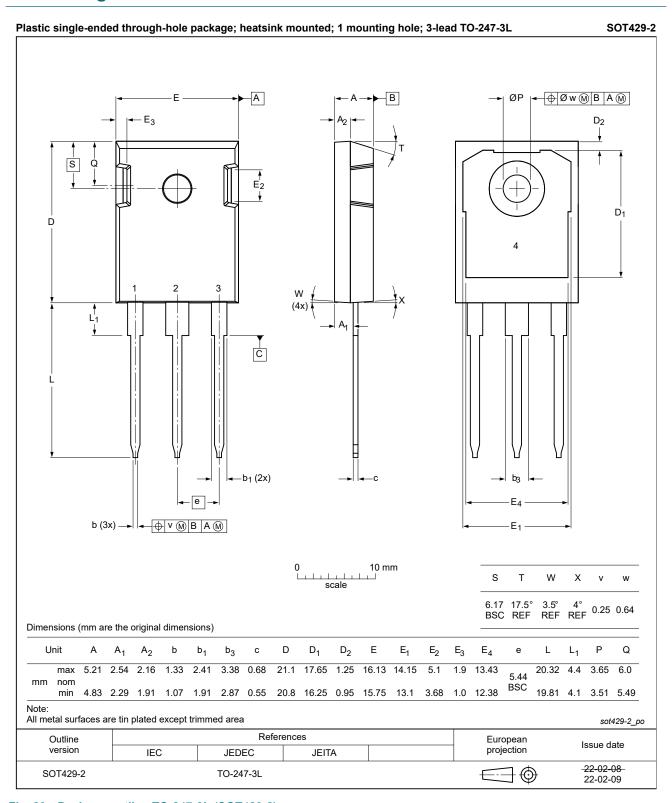


Fig. 29. Package outline TO-247-3L (SOT429-2)

11. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NGW50T65H3DFP v. 1	20240628	Product data sheet	-	-

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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